

DSP56301

24-Bit Digital Signal Processor

The DSP56301 is a member of the DSP56300 core family of programmable CMOS DSPs. This family uses a high-performance, single clock cycle per instruction engine. Significant architectural features of the DSP56300 core family include a barrel shifter, 24-bit addressing, instruction cache, and DMA. The DSP56301 performs at 66/80/100 MIPS using an internal 66/80/100 MHz clock at 3.0–3.6 volts. The DSP56300 core family offers a rich instruction set and low power dissipation, as well as increasing levels of speed and power, enabling wireless, telecommunications, and multimedia products.

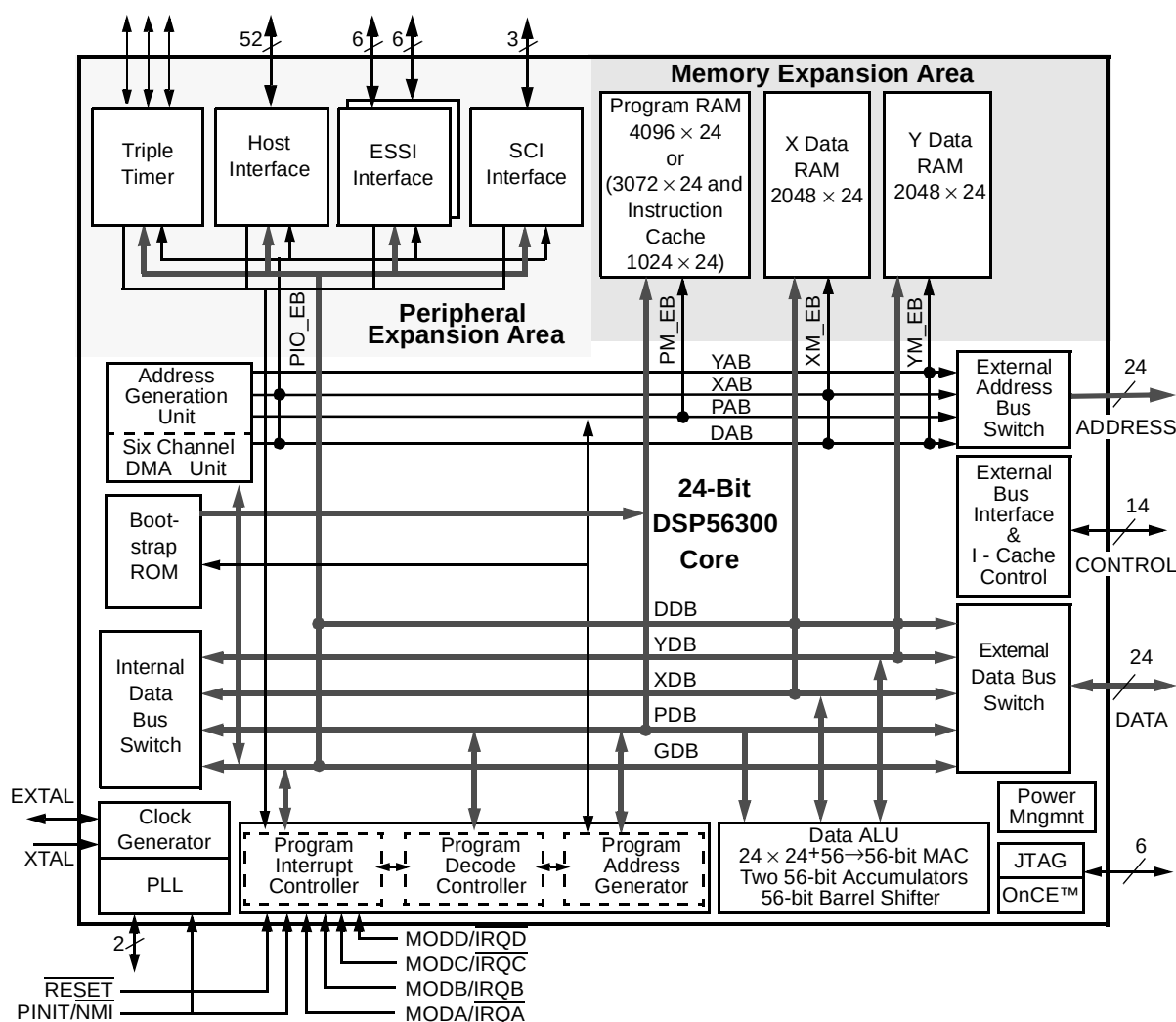


Figure 1. DSP56301 Block Diagram

DSP56301 Features

- High-performance DSP56300 core
 - 66/80/100 Million Instructions Per Second (MIPS) with a 66/80/100 MHz clock at 3.3 V
 - Object code compatible with the DSP56000 core
 - Highly parallel instruction set
 - Fully pipelined 24 x 24-bit parallel multiplier-accumulator
 - 56-bit parallel barrel shifter
 - 24-bit or 16-bit arithmetic support under software control
 - Position independent code support
 - Addressing modes optimized for DSP applications
 - On-chip instruction cache controller
 - On-chip memory-expandable hardware stack
 - Nested hardware DO loops
 - Fast auto-return interrupts
 - On-chip concurrent six-channel DMA controller
 - On-chip Phase Lock Loop (PLL) and clock generator
 - On-Chip Emulation (OnCE™) module
 - Joint Action Test Group (JTAG) Test Access Port (TAP)
 - Address tracing mode that reflects internal accesses at the external port

- On-chip memories

- Program RAM, Instruction Cache, X data RAM, and Y data RAM size are programmable:

Instruction Cache	Switch Mode	Program RAM Size	Instruction Cache Size	X Data RAM Size	Y Data Ram Size
disabled	disabled	4096 × 24-bit	0	2048 × 24-bit	2048 × 24-bit
enabled	disabled	3072 × 24-bit	1024 × 24-bit	2048 × 24-bit	2048 × 24-bit
disabled	enabled	2048 × 24-bit	0	3072 × 24-bit	3072 × 24-bit
enabled	enabled	1024 × 24-bit	1024 × 24-bit	3072 × 24-bit	3072 × 24-bit

- 192 × 24-bit bootstrap ROM
- Off-chip memory expansion
 - Data memory expansion to two 16 M x 24-bit word memory spaces
 - Program memory expansion to one 16 M x 24-bit word memory space
 - External memory expansion port
 - Chip Select Logic requiring no additional circuitry to interface to SRAMs and SSRAMs
 - On-chip DRAM controller that requires no additional circuitry to interface to DRAMs
- On-chip peripherals
 - 32-bit parallel PCI/Universal Host Interface (HI32), PCI Rev. 2.1 compliant with no additional interface logic required for other DSP563xx buses
 - ISA interface requires only 74LS45-style buffer
 - Two Enhanced Synchronous Serial Interfaces (ESSI)
 - Serial Communications Interface (SCI) with baud rate generator
 - Triple timer module
 - Up to 42 programmable General Purpose I/O pins (GPIO), depending on which peripherals are enabled
- Reduced power dissipation
 - Very low power CMOS design
 - Wait and Stop low power standby modes
 - Fully-static logic, operation frequency down to 0 Hz (DC)
 - Optimized power management circuitry

Target Applications

The DSP56301 is intended as for general-purpose digital signal processing, particularly in multimedia and telecommunication applications, such as videoconferencing and cellular telephony.

Product Documentation

The documents listed in **Table 1** are required for a complete description of the DSP56301 and are necessary to design with the part properly. Documentation is available from a local Freescale distributor, a Freescale semiconductor sales office, a Freescale Literature Distribution Center, or the Freescale web site listed on the back cover of this document.

Table 1. DSP56301 Documentation

Topic	Description	Order Number
DSP56300 Family Manual	Detailed description of the DSP56300 family architecture and the 24-bit core processor and instruction set	DSP56300FM
DSP56301 User's Manual	Detailed description of DSP56301 memory, peripherals, and interfaces	DSP56301UM
DSP56301 Technical Data	DSP56301 pin and package descriptions; electrical and timing specifications	DSP56301

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